MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

Broduct data sheet



SMA

FEATURES

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Fast switching for high efficiency
- Low reverse leakage
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed: 250°C/10 seconds at terminals

MECHANICAL DATA

Case: JEDEC DO-214AC molded plastic body

Terminals: Solder plated, solderable per MIL-STD-750,

Method 2026

Polarity: Color band denotes cathode end Mounting Position: Any Weight: 0.003 ounce, 0.093 grams

0.004 ounce, 0.111 grams SMA(H)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25℃ ambient temperature unless otherwise specified. Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

Characteristic	SYMBOLS	RS1A	RS1B	RS1D	RS1G	RS1J	RS1K	RS1M	UNITS
Maximum repetitive peak reverse voltage		50	100	200	400	600	800	1000	V
Maximum RMS voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at TL=90°C	l _(AV)			•	1.0				Α
Peak forward surge current									
8.3ms single half sine-wave superimposed on		30.0				Α			
rated load (JEDEC Method)									
Maximum instantaneous forward voltage at 1.0A	V _F				1.3				V
Maximum DC reverse current Ta=25°C	5.0								
at rated DC blocking voltage T _A =100°C	l _R	50.0					μA		
Maximum reverse recovery time (NOTE 1)	trr		15	0		250	50	00	ns
Typical junction capacitance (NOTE 2)	Сл				15.0				pF
Typical thermal resistance (NOTE 3)	Reja				50.0				°C/W
Operating junction and storage temperature range		-65 to +150			°C				

Note:1.Reverse recovery condition IF=0.5A,IR=1.0A,Irr=0.25A 2.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

3.P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas







AVERAGE FORWARD RECTIFIED CURRENT, AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE 1.0 8.0 0.6 Single Phase Half Wave 60Hz Resistive or inductive Load 0.4 0.2 0 25 75 50 100 125 150 175 AMBIENT TEMPERATURE,°C

PEAK FORWARD SURGE CURRENT, AMPERES

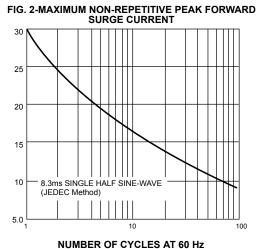


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

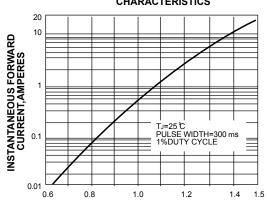
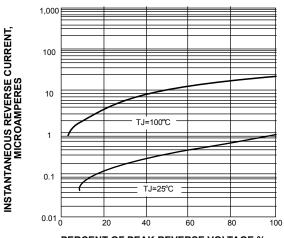
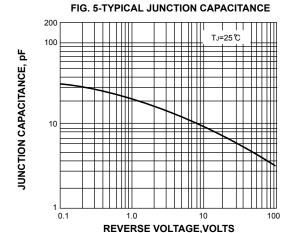


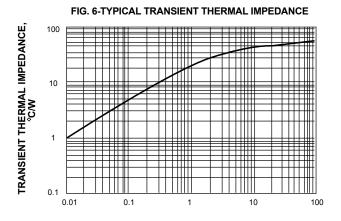
FIG. 4-TYPICAL REVERSE CHARACTERISTICS



INSTANTANEOUS FORWARD VOLEAGE, VOLTS



PERCENT OF PEAK REVERSE VOLTAGE,%

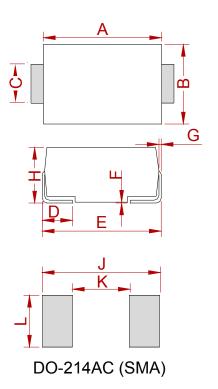


t,PULSE DURATION,sec.





PACKAGE MECHANICAL DATA



		Dimensions						
Ref.	Millir	neters	Inches					
	Min.	Max.	Min.	Max.				
Α	4.25	4.65	0.167	0.183				
В	2.50	2.90	0.098	0.114				
С	1.35	1.65	0.053	0.065				
D	0.76	1.52	0.030	0.060				
Е	4.93	5.28	0.194	0.208				
F	0.051	0.203	0.002	0.008				
G	0.15	0.31	0.006	0.012				
Н	1.98	2.41	0.078	0.095				
J	6.50		0.256					
K		2.30		0.090				
L	1.70		0.067					

REEL SPECIFICATION

P/N	PKG	QTY
RS1A THRU RS1M	SMA	2000



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